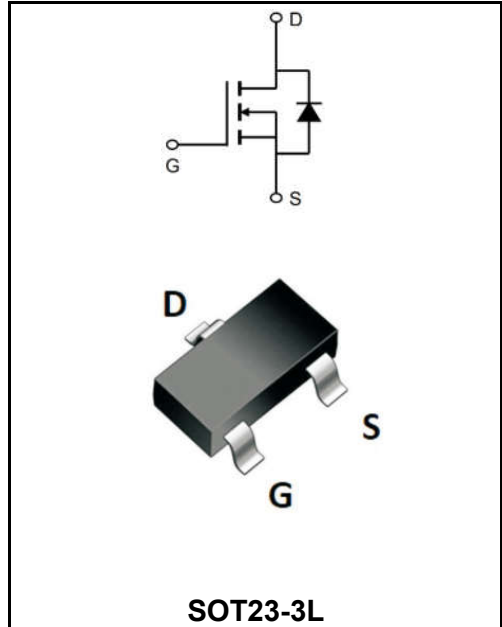


30V N-CHANNEL ENHANCEMENT MODE MOSFET

MAIN CHARACTERISTICS

I_D	13A
V_{DSS}	30V
R_{DS(on)-typ}(@V_{GS}=10V)	< 15mΩ(Type:11 mΩ)



Application

- ◆ Battery protection
- ◆ Load switch
- ◆ Uninterruptible power supply

Product Specification Classification

Part Number	Package	Marking	Pack
YFW3410MI	SOT23-3L	X10V-34	3000PCS/Tape

Maximum Ratings at T_c=25°C unless otherwise specified

Characteristics	Symbols	Value	Units
Drain-Source Voltage	V_{DS}	30	V
Gate - Source Voltage	V_{GS}	±20	V
Continuous Drain Current, V _{GS} @ 10V ¹ @T _c =25°C	I_D	13	A
Continuous Drain Current, V _{GS} @ 10V ¹ @T _c =100°C	I_D	8.5	A
Pulsed Drain Current ²	I_{DM}	39	A
Single Pulse Avalanche Energy ³	E_{AS}	11	mJ
Total Power Dissipation ⁴ @T _c =25°C	P_D	42	W
Storage Temperature Range	T_{STG}	-55 to +150	°C
Operating Junction Temperature Range	T_J	-55 to +150	°C
Thermal Resistance Junction-ambient ¹	R_{θJA}	125	°C/W
Thermal Resistance Junction-Case ¹	R_{θJC}	3	°C/W

Maximum Ratings at Tc=25°C unless otherwise specified

Characteristics	Test Condition	Symbols	Min	Typ	Max	Units
Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	BV_{DSS}	30	32	-	V
BVDSS Temperature Coefficient	Reference to 25°C, $I_D=1mA$	$\Delta BV_{DSS}/\Delta T_J$	-	0.0193	-	V/°C
Static Drain-Source On-Resistance ²	$V_{GS}=10V, I_D=30A$	$R_{DS(ON)}$	-	11	15	mΩ
	$V_{GS}=4.5V, I_D=15A$		-	18	25	
Gate -Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	$V_{GS(th)}$	1.2	1.6	2.5	V
$V_{GS(th)}$ Temperature Coefficient		$\Delta V_{GS(th)}$	-	-3.97	-	mV/°C
Drain-Source Leakage Current	$V_{DS}=24V, V_{GS}=0V, T_J=25^\circ C$	I_{DSS}	-	-	1	μA
	$V_{DS}=24V, V_{GS}=0V, T_J=55^\circ C$		-	-	5	
Gate -Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	I_{GSS}	-	-	±100	nA
Forward Transconductance	$V_{DS}=5V, I_D=30A$	g_{fs}	-	34	-	S
Gate Resistance	$V_{DS}=0V, V_{GS}=0V, f=1MHz$	R_g	-	1.8	-	Ω
Total Gate Charge(4.5V)	$V_{DS}=15V$ $V_{GS}=4.5V$ $I_D=15A$	Q_g	-	9.8	-	nC
Gate-Source Charge		Q_{gs}	-	4.2	-	
Gate-Drain Charge		Q_{gd}	-	3.6	-	
Turn-on delay time	$V_{DD}=15V$ $V_{GS}=10V$ $R_G=3.3\Omega$ $I_D=15A$	$t_{d(on)}$	-	4	-	ns
Rise Time		T_r	-	8	-	
Turn-Off Delay Time		$t_{d(OFF)}$	-	31	-	
Fall Time		t_f	-	4	-	
Input Capacitance	$V_{DS}=15V$ $V_{GS}=0V$ $f=1.0MHz$	C_{iss}	-	940	-	pF
Output Capacitance		C_{oss}	-	131	-	
Reverse Transfer Capacitance		C_{rss}	-	109	-	
Continuous Source Current ^{1,5}	$V_G=V_D=0V, \text{Force Current}$	I_S	-	-	43	A
Pulsed Source Current ^{2,5}		I_{SM}	-	-	112	A
Diode Forward Voltage ²	$V_{GS}=0V, I_S=1A, T_J=25^\circ C$	V_{SD}	-	-	1	V
Reverse Recovery Time	$I_F=30A, di/dt=100A/\mu s, T_J=25^\circ C$	t_{rr}	-	8.5	-	ns
Reverse Recovery Charge		Q_{rr}	-	2.2	-	nC

Note :

- 1、The data tested by surface mounted on a 1 inch 2 FR-4 board with 2OZ copper.
- 2、The data tested by pulsed , pulse width $\cong 300\mu s$, duty cycle $\cong 2\%$
- 3、The power dissipation is limited by 150°C junction temperature
- 4、The data is theoretically the same as I D and I DM , in real applications , should be limited by total power dissipation.

Ratings and Characteristic Curves

Typical Characteristics

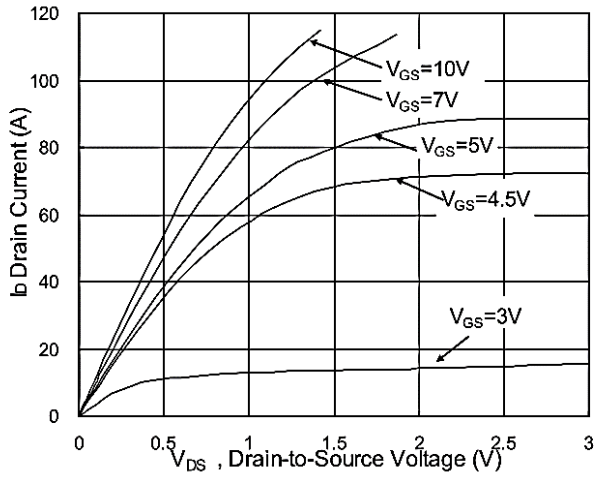


Fig.1 Typical Output Characteristics

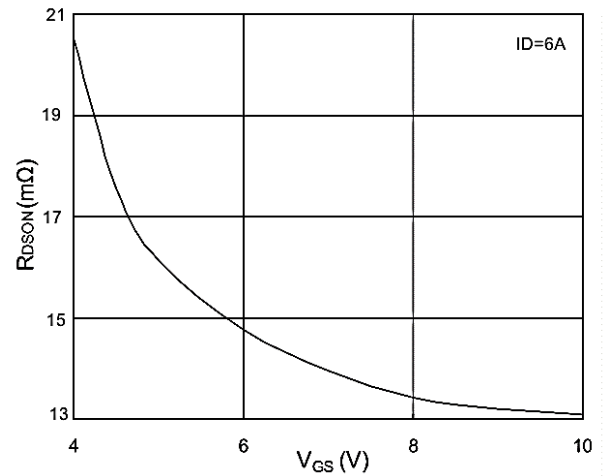


Fig.2 On-Resistance vs. G-S Voltage

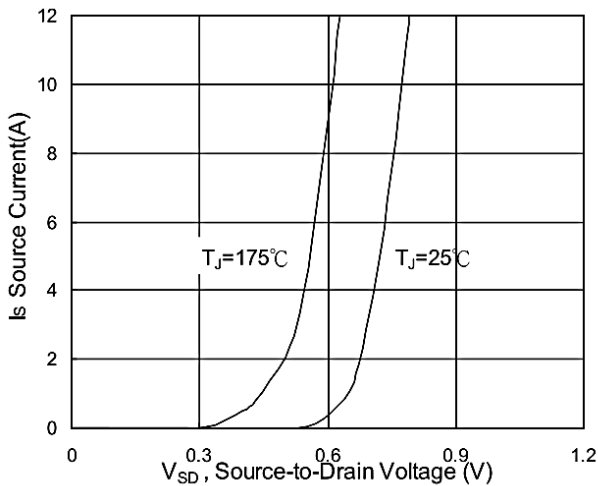


Fig.3 Forward Characteristics of Reverse

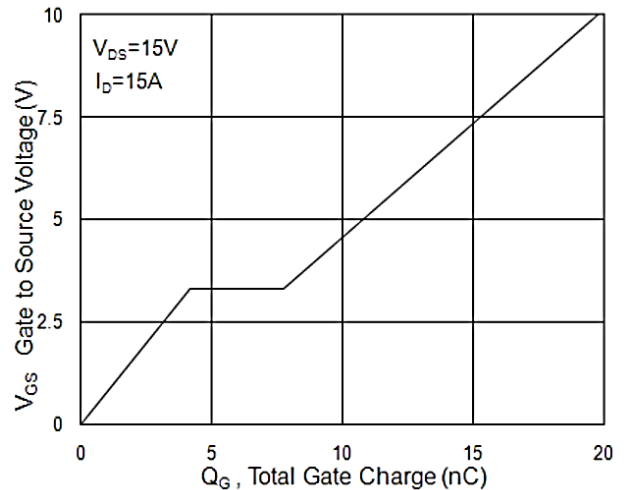


Fig.4 Gate-Charge Characteristics

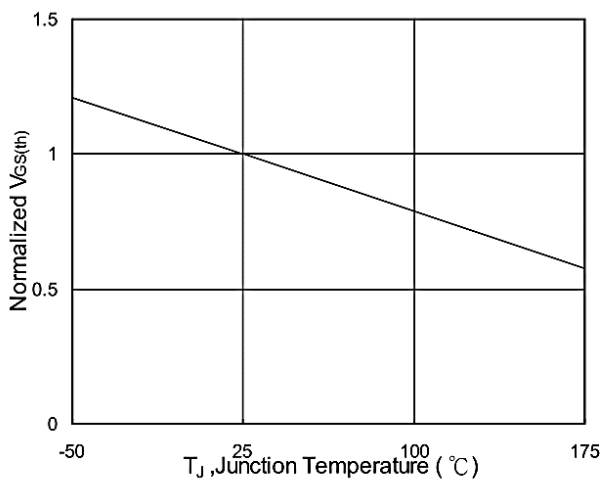


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

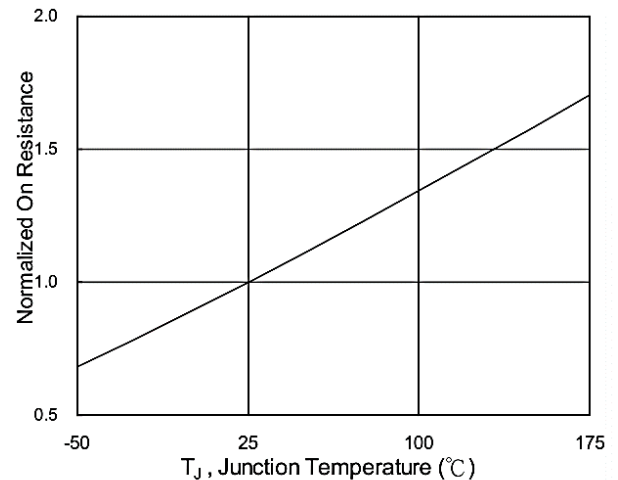


Fig.6 Normalized $R_{DS(on)}$ vs. T_J

Ratings and Characteristic Curves

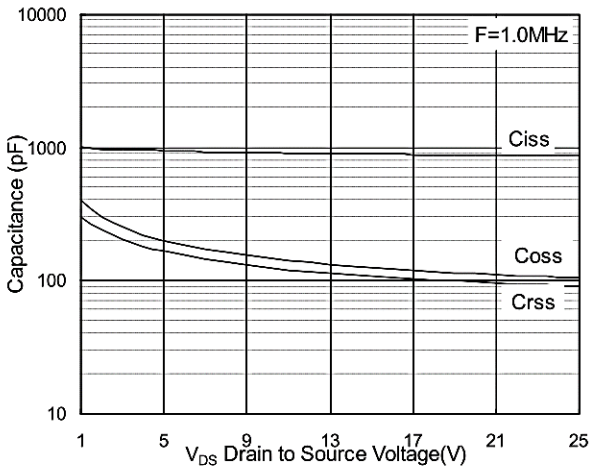


Fig.7 Capacitance

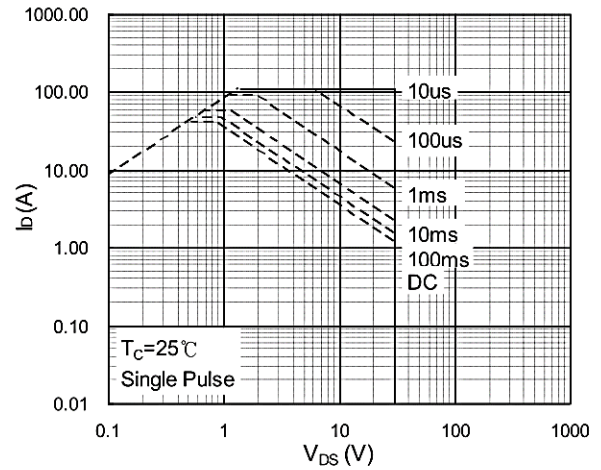


Fig.8 Safe Operating Area

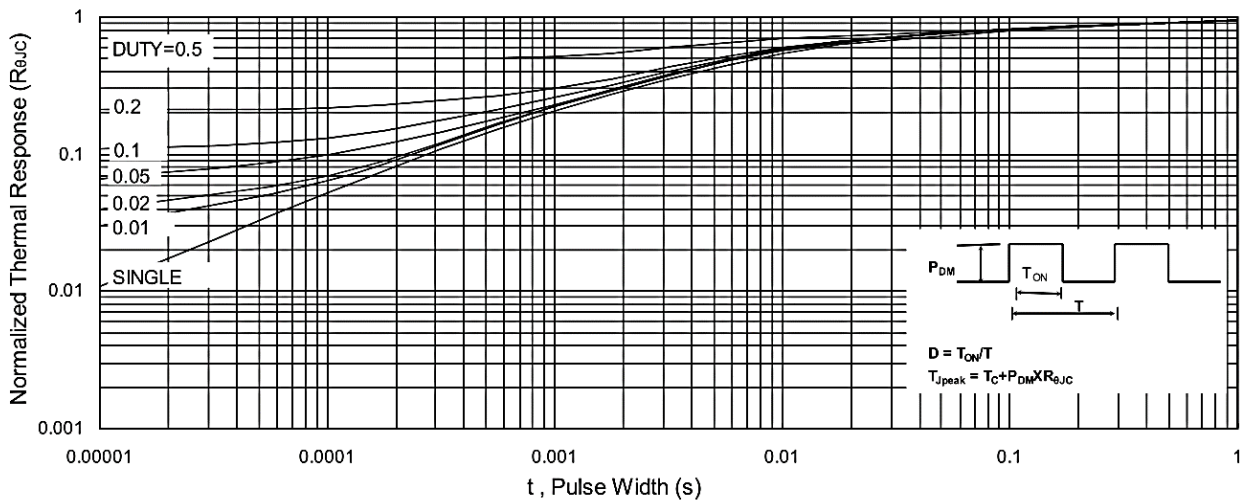


Fig.9 Normalized Maximum Transient Thermal Impedance

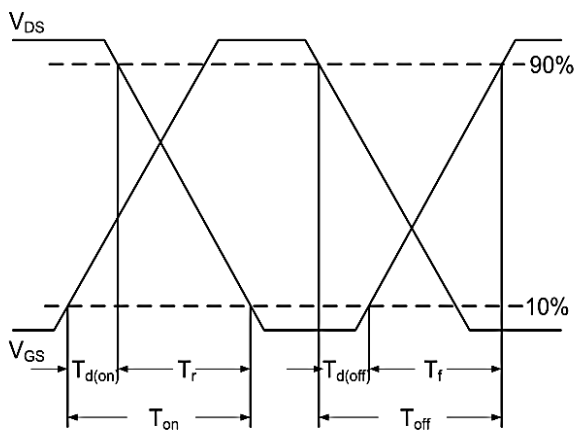


Fig.10 Switching Time Waveform

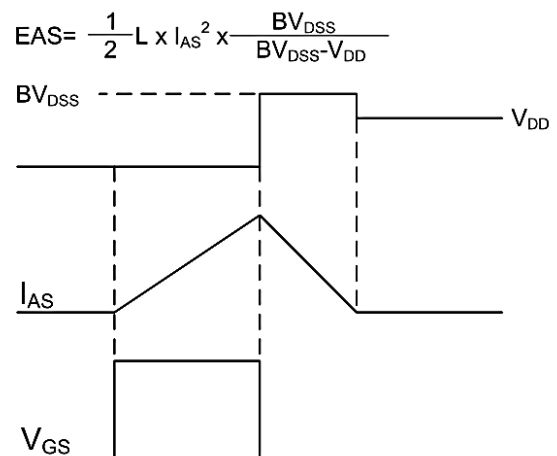
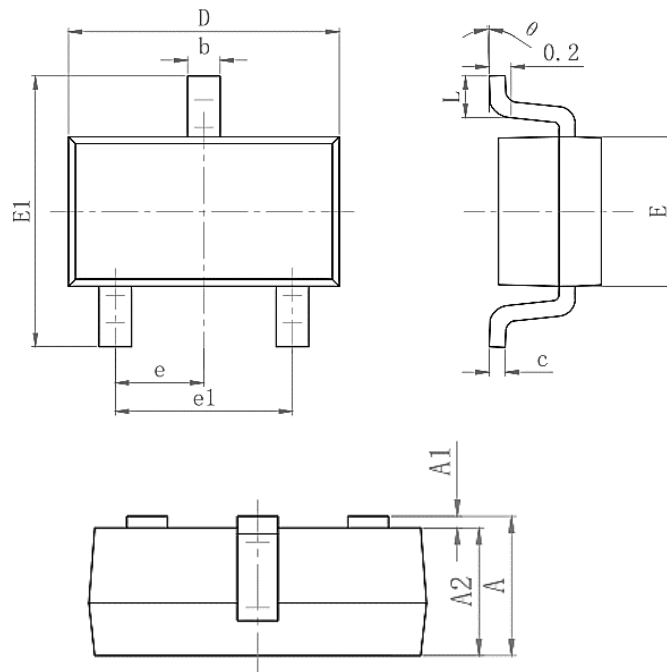


Fig.11 Unclamped Inductive Switching Waveform

Package Outline Dimensions Millimeters

SOT23-3L



Symbol	Dimensions in Millimeters	
	mm	
	Min	Max
A	1.05	1.25
A1	0.000	0.100
A2	1.05	1.15
b	0.25	0.45
c	0.100	0.200
D	2.820	3.020
E	1.500	1.700
E1	2.650	2.950
e	0.950 (BSC)	
e1	1.800	2.000
L	0.300	0.500
θ	0°	8°